

### General Description

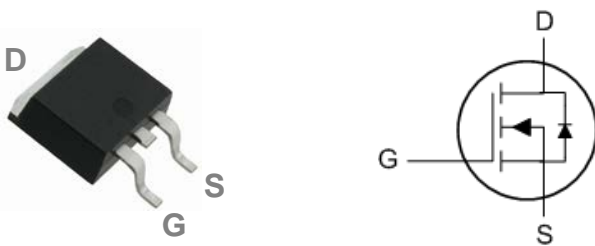
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

|       |       |     |
|-------|-------|-----|
| BVDSS | RDSON | ID  |
| 30V   | 6mΩ   | 80A |

### Features

- 30V,80A,  $R_{DS(ON)} = 6m\Omega @ V_{GS} = 10V$
- Improved  $dv/dt$  capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

### TO252 Pin Configuration



### Applications

- MB / VGA / Vcore
- POL Applications
- SMPS 2<sup>nd</sup> SR

### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

| Symbol    | Parameter  | Rating     | Units               |
|-----------|--|------------|---------------------|
| $V_{DS}$  | Drain-Source Voltage                                   | 30         | V                   |
| $V_{GS}$  | Gate-Source Voltage                                    | $\pm 20$   | V                   |
| $I_D$     | Drain Current – Continuous ( $T_C=25^\circ\text{C}$ )  | 80         | A                   |
|           | Drain Current – Continuous ( $T_C=100^\circ\text{C}$ ) | 51         | A                   |
| $I_{DM}$  | Drain Current – Pulsed <sup>1</sup>                    | 320        | A                   |
| EAS       | Single Pulse Avalanche Energy <sup>2</sup>             | 88         | mJ                  |
| IAS       | Single Pulse Avalanche Current <sup>2</sup>            | 42         | A                   |
| $P_D$     | Power Dissipation ( $T_C=25^\circ\text{C}$ )           | 54         | W                   |
|           | Power Dissipation – Derate above $25^\circ\text{C}$    | 0.43       | W/ $^\circ\text{C}$ |
| $T_{STG}$ | Storage Temperature Range                              | -55 to 150 | $^\circ\text{C}$    |
| $T_J$     | Operating Junction Temperature Range                   | -55 to 150 | $^\circ\text{C}$    |

### Thermal Characteristics

| Symbol          | Parameter                              | Typ. | Max. | Unit               |
|-----------------|--|------|------|--------------------|
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | ---  | 62   | $^\circ\text{C/W}$ |
| $R_{\theta JC}$ | Thermal Resistance Junction to Case    | ---  | 2.3  | $^\circ\text{C/W}$ |

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**
**Static State Characteristics**

| Symbol                       | Parameter                                      | Conditions   | Min. | Typ. | Max.      | Unit                |
|------------------------------|--|--|------|------|-----------|---------------------|
| $BV_{DSS}$                   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V, I_D=250\mu A$                          | 30   | ---  | ---       | V                   |
| $\Delta BV_{DSS}/\Delta T_J$ | $BV_{DSS}$ Temperature Coefficient             | Reference to $25^\circ\text{C}$ , $I_D=1\text{mA}$ | ---  | 0.04 | ---       | $V/^\circ\text{C}$  |
| $I_{DSS}$                    | Drain-Source Leakage Current                   | $V_{DS}=30V, V_{GS}=0V, T_J=25^\circ\text{C}$      | ---  | ---  | 1         | $\mu A$             |
|                              |  | $V_{DS}=24V, V_{GS}=0V, T_J=125^\circ\text{C}$     | ---  | ---  | 10        | $\mu A$             |
| $I_{GSS}$                    | Gate-Source Leakage Current                    | $V_{GS}=\pm 20V, V_{DS}=0V$                        | ---  | ---  | $\pm 100$ | nA                  |
| $R_{DS(ON)}$                 | Static Drain-Source On-Resistance <sup>3</sup> | $V_{GS}=10V, I_D=20A$                              | ---  | 4.8  | 6         | $m\Omega$           |
|                              |  | $V_{GS}=4.5V, I_D=10A$                             | ---  | 6.5  | 9         | $m\Omega$           |
| $V_{GS(th)}$                 | Gate Threshold Voltage                         | $V_{GS}=V_{DS}, I_D=250\mu A$                      | 1    | 1.6  | 2.5       | V                   |
| $\Delta V_{GS(th)}$          | $V_{GS(th)}$ Temperature Coefficient           |  | ---  | -4   | ---       | $mV/^\circ\text{C}$ |
| $g_{fs}$                     | Forward Transconductance                       | $V_{DS}=10V, I_D=10A$                              | ---  | 18   | ---       | S                   |

**Dynamic Characteristics**

|              |                                    |  |     |      |     |          |
|--------------|------------------------------------|--|-----|------|-----|----------|
| $Q_g$        | Total Gate Charge <sup>3,4</sup>   | $V_{DS}=15V, V_{GS}=4.5V, I_D=20A$                   | --- | 11.1 | --- | nC       |
| $Q_{gs}$     | Gate-Source Charge <sup>3,4</sup>  |  | --- | 1.85 | --- |          |
| $Q_{gd}$     | Gate-Drain Charge <sup>3,4</sup>   |  | --- | 6.8  | --- |          |
| $T_{d(on)}$  | Turn-On Delay Time <sup>3,4</sup>  | $V_{DD}=15V, V_{GS}=10V, R_G=3.3\Omega$<br>$I_D=15A$ | --- | 7.5  | --- | ns       |
| $T_r$        | Rise Time <sup>3,4</sup>           |  | --- | 14.5 | --- |          |
| $T_{d(off)}$ | Turn-Off Delay Time <sup>3,4</sup> |  | --- | 35.2 | --- |          |
| $T_f$        | Fall Time <sup>3,4</sup>           |  | --- | 9.6  | --- |          |
| $C_{iss}$    | Input Capacitance                  | $V_{DS}=25V, V_{GS}=0V, F=1\text{MHz}$               | --- | 1160 | --- | pF       |
| $C_{oss}$    | Output Capacitance                 |  | --- | 200  | --- |          |
| $C_{riss}$   | Reverse Transfer Capacitance       |  | --- | 180  | --- |          |
| $R_g$        | Gate resistance                    | $V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$                | --- | 2.5  | --- | $\Omega$ |

**Guaranteed Avalanche Energy**

| Symbol | Parameter                     | Conditions                               | Min. | Typ. | Max. | Unit |
|--------|-------------------------------|--|------|------|------|------|
| EAS    | Single Pulse Avalanche Energy | $V_{DD}=25V, L=0.1\text{mH}, I_{AS}=20A$ | 20   | ---  | ---  | mJ   |

**Drain-Source Diode Characteristics**

| Symbol   | Parameter                          | Conditions                                | Min. | Typ. | Max. | Unit |
|----------|------------------------------------|---|------|------|------|------|
| $I_S$    | Continuous Source Current          | $V_G=V_D=0V$ , Force Current              | ---  | ---  | 80   | A    |
| $I_{SM}$ | Pulsed Source Current <sup>3</sup> |   | ---  | ---  | 320  | A    |
| $V_{SD}$ | Diode Forward Voltage <sup>3</sup> | $V_{GS}=0V, I_S=1A, T_J=25^\circ\text{C}$ | ---  | ---  | 1    | V    |
| $t_{rr}$ | Reverse Recovery Time              | $V_{GS}=0V, I_S=1A, di/dt=100A/\mu s$     | ---  | ---  | ---  | ns   |
| $Q_{rr}$ | Reverse Recovery Charge            | $T_J=25^\circ\text{C}$                    | ---  | ---  | ---  | nC   |

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{DD}=25V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=42A, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
3. The data tested by pulsed, pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.

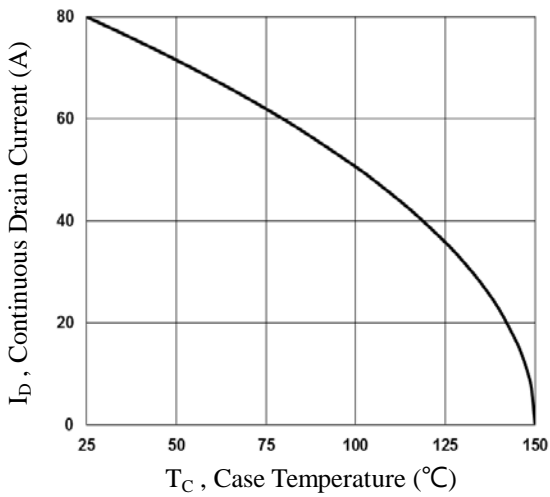


Fig.1 Continuous Drain Current vs.  $T_c$

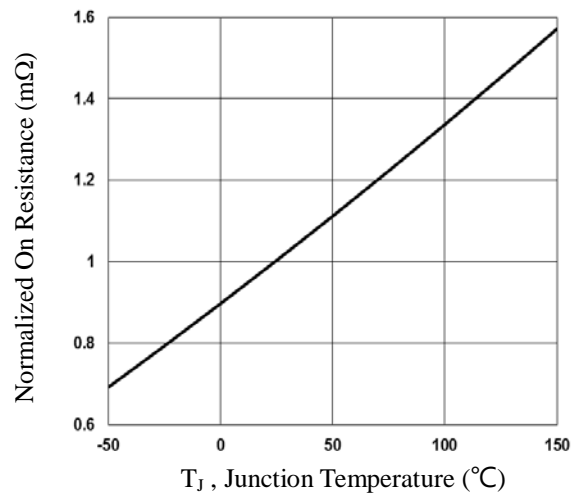


Fig.2 Normalized  $R_{DS(on)}$  vs.  $T_j$

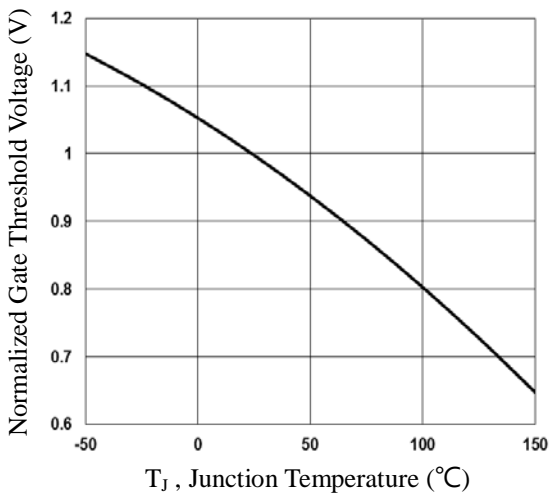


Fig.3 Normalized  $V_{th}$  vs.  $T_j$

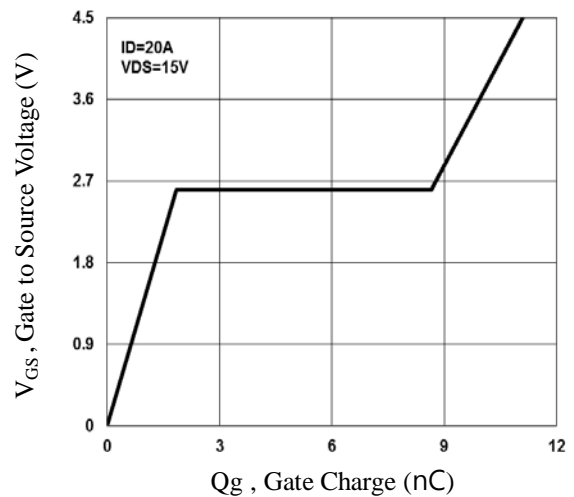


Fig.4 Gate Charge Waveform

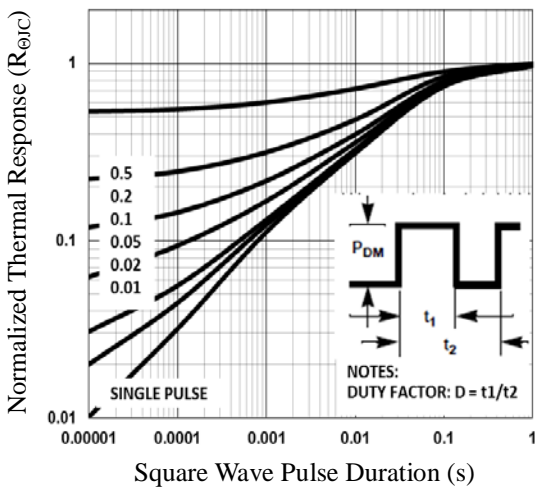


Fig.5 Normalized Transient Impedance

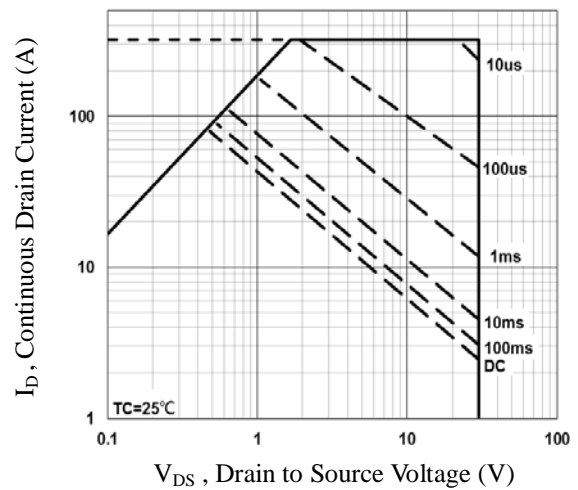


Fig.6 Maximum Safe Operation Area

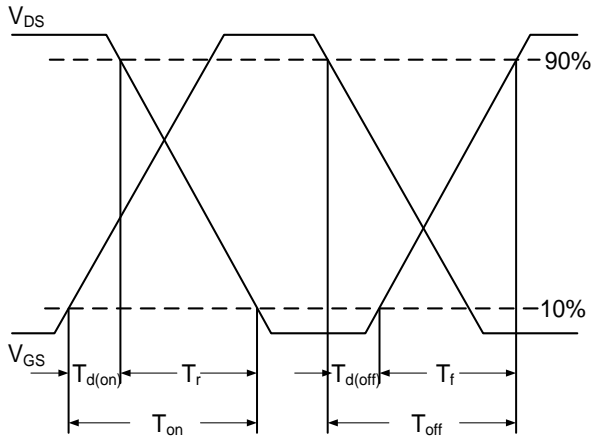


Fig.7 Switching Time Waveform

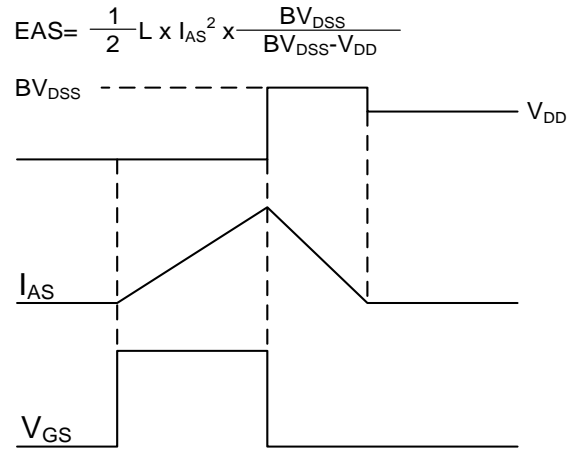
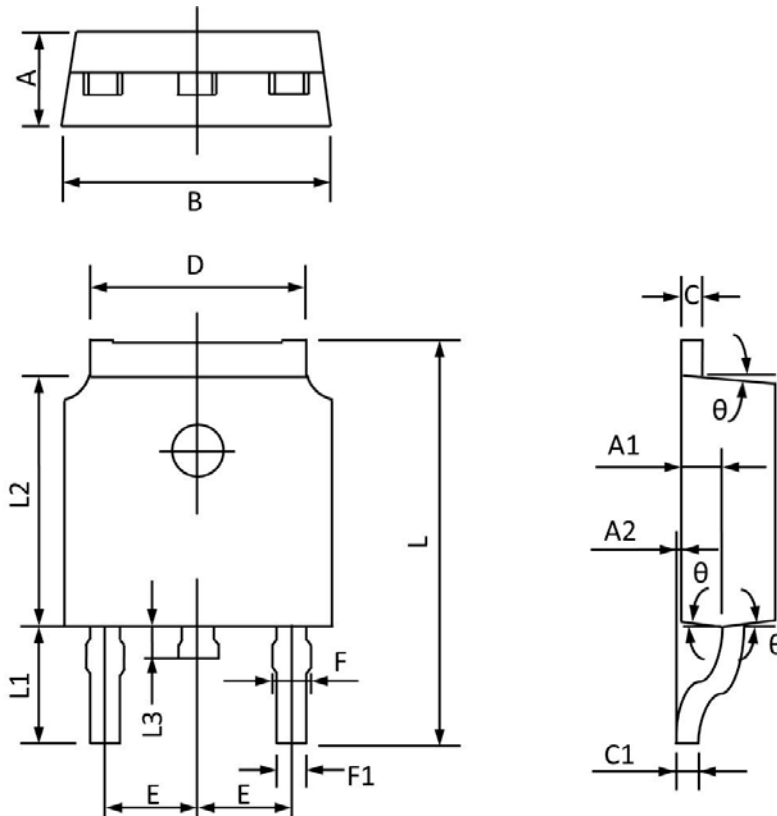


Fig.8 EAS Waveform

## TO252 PACKAGE INFORMATION



| Symbol   | Dimensions In Millimeters |       | Dimensions In Inches |       |
|----------|---------------------------|-------|----------------------|-------|
|          | Min                       | Max   | Min                  | Max   |
| A        | 2.20                      | 2.40  | 0.087                | 0.094 |
| A1       | 0.91                      | 1.11  | 0.036                | 0.044 |
| A2       | 0.00                      | 0.15  | 0.000                | 0.006 |
| B        | 6.50                      | 6.70  | 0.256                | 0.264 |
| C        | 0.46                      | 0.580 | 0.018                | 0.230 |
| C1       | 0.46                      | 0.580 | 0.018                | 0.030 |
| D        | 5.10                      | 5.46  | 0.201                | 0.215 |
| E        | 2.186                     | 2.386 | 0.086                | 0.094 |
| F        | 0.74                      | 0.94  | 0.029                | 0.037 |
| F1       | 0.660                     | 0.860 | 0.026                | 0.034 |
| L        | 9.80                      | 10.40 | 0.386                | 0.409 |
| L1       | 2.9REF                    |       | 0.114REF             |       |
| L2       | 6.00                      | 6.20  | 0.236                | 0.244 |
| L3       | 0.60                      | 1.00  | 0.024                | 0.039 |
| $\theta$ | 3°                        | 9°    | 3°                   | 9°    |